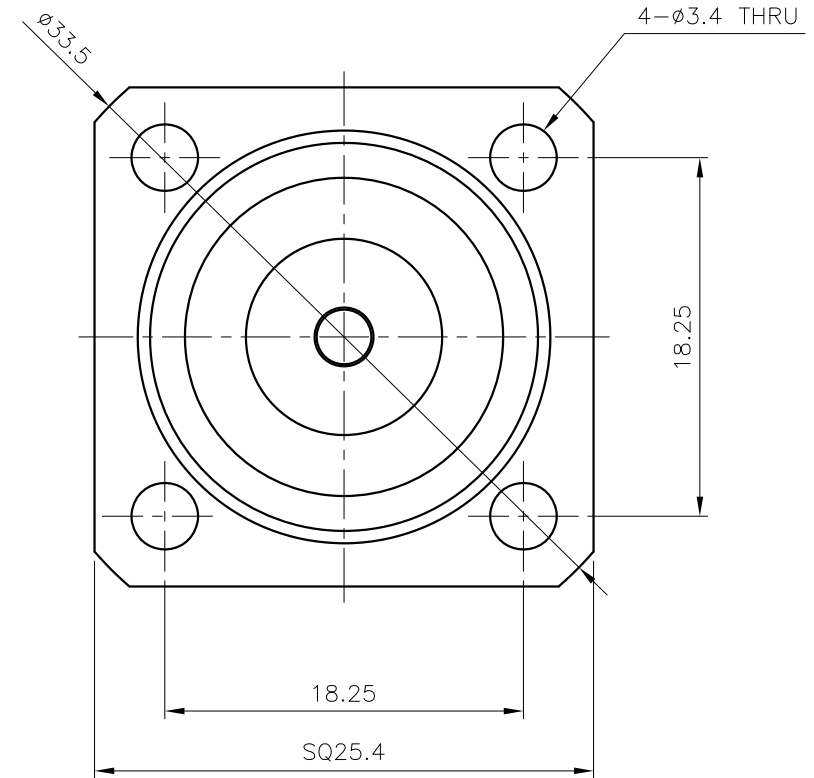
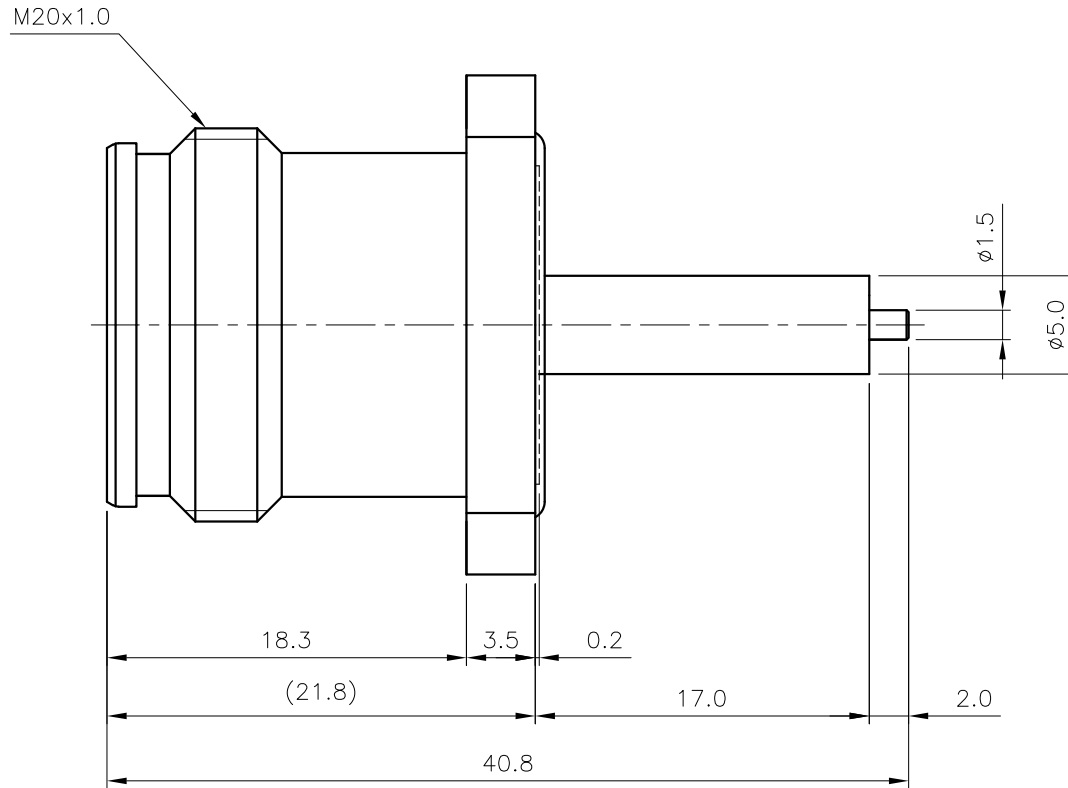


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2023. 08. 18.



※ 가공 시 부터 트레이 관리 할 것
 ※ 외관 스크래치, 찍힘 주의

ELECTRICAL DATA

1	Frequency range	DC ~ 6.0 GHz
2	IMPEDANCE	50Ω NOMINAL
3	V.S.W.R	1.2 : 1 max
4	Insertion Loss	-0.2dB min
5	PIMD	160dBc (Min) (20W*2Tone)

5	JACK	1	MBsBD C3604BD-F	Silver Plate (3μm)	DJA00228-5/6
4	INSULATOR	1	TEFLON		DIN03369-N/1
3	GASKET	1	SILICONE RUB		DGK00179-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (3μm)	DCT04396-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate	DBD04715-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 08. 18.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY				
MATERIAL _____		CHECKED BY			TITLE 4.3-10 SOLDER END JS-4H	
		DRAWN BY S.H.KIM				
FINISH _____		SCALE 2.5/1	UNIT mm		A4	DWG NO. CN03984-7/3
						REVISION I R